## **TECHSIL** Solutions for LED Assembly



## Adding value to LED Lighting

# LED Encapsulants, LED Potting and Protection

Techsil provide a wide range of materials for LED assembly, sealing and protection from harsh environmental factors such as moisture ingress, vibration and thermal shock. Designed to have, in particular, an excellent refractive index, all materials have great UV stability. Techsil's materials are used in but not limited to LED light engines, linear modules, luminaires, housings, architectural lighting, security and flood lighting, outdoor LEDs, oceanic LEDs, panel mounted LEDs and PCB mountings for example.

Product	RTV27844 Clear	RTV28418 Pearl	VT2420LV Clear	VT2420HD Clear	PU20490 Black	PU23930 Pearl
Chemistry	2 part Silicone	2 part Silicone	2 part Polyurethane	2 part Polyurethane	2 part Polyurethane	2 part Polyurethane
Features	Potting & Encapsulation. Excellent environmental resistance RI=1.41 FDA Approved	UL-94 HB approved Primerless Adhesion, Diffused Light	Clear Potting, Rl=1.48 Pourable	Clear Potting RI=1.48 Pourable Scratch Resistant	UL-94 VO approved, Improves reflection	Scratch resistant, high mechanical strength Opalescent
	1.02	1.0	1.11	1.09	1.65	1.11
Mixed Viscosity	4,000 mPas	1500 mPas	700 mPas	1,700 mPas	6,000 mPas	400 mPas
Mix Ratio	10:1	20:1	1:1	1:1	8.4:1	1:1
Pot Life	4 hrs	100 mins	15mins	25 mins	6 hrs	30 mins
Initial Cure Time	1 hr at 100°C 4 hrs at 65°C	3 hrs	2 hrs	48 hrs	7 days	60 mins
Full Cure	24 hrs	72 hrs	48 hrs	72 hrs	7 days	48 hrs
Shore Hardness	44A	18A	70A	80D	90A	30D
Thermal Conductivity	0.45 W/mK	0.18 W/mK	0.25 W/mK	0.25 W/mK	0.75 W/mK	0.25 W/mK
Temp. Performance	-55° to 204°C	-60° to 204°C	-55º to 120ºC	-55º to 120ºC	-40º to 125ºC	-55° to 120°C



### Thermal Management Sealants and Adhesives

When designing luminaires and modules, LED Design Engineers use a variety of liquid materials to provide environmental protection, extend service life and improved light performance. Techsil's materials are easy to mix and process; and in addition they have thermal management properties to dissipate heat from the rear of the diode.

Product	RTV1084 Grey	RTV12130 Clear	RTV12120 Clear	RTV27462 Dark Grey	EP21292 Black	PU2600FS White
Chemistry	1 part Silicone	1 part Silicone	1 part Silicone	2 part Silicone	2 part Epoxy	2 part Polyurethane
Features	Thermal Management. Adhesive Non-corrosive	Coating for PCB protection. Adhesive	Seals lens in a bezel	UL-94 VO Flame Retardent 1:1 Pourable Potting Adhesive	UL94-VO, Thermal Management & High Temp	Heat dissipation, can co-cure with VT2420LV Approvable to UL94 V0 Flame retardent
	2.11	1.04	1.04	1.38	1.96	1.48
Mixed Viscosity	350,000 mPas	2,500 mPas	50,000 mPas	1270 mPas	9,500 mPas	3,000 mPas
Mix Ratio	N/A	N/A	N/A	1:1	9.6:1	3.8:1
Initial Cure Time	4 mins	10 mins	10 mins	1 hr at 100°C 4 hrs at 64°C	6 hrs	30-60 mins
Full Cure	24 hrs	24 hrs	24 hrs	48 hrs	36 hrs	7 days
Shore Hardness	67A	30A	20A	62A	92D	80D
Thermal Conductivity	2.3 W/mK	0.18 W/mK	0.18 W/mK	0.31 W/mK	1.3 W/mK	0.8 W/mK
Temp. Performance	-50°C to 220°C	-55°C to 200°C	-55°C to 200°C	-60°C to 204°C	-55°C to 200°C	-55°C to 140°C



#### Thermal Compounds, Greases and Tapes

Techsil recognised the need for a full suite of thermal management materials specifically for the LED lighting industry and have selected some high performance compounds, greases and pressure sensitive adhesive tapes for bonding heat sinks and providing an excellent thermal path.

Product	TIM11007 White	TIM11021 Grey	TIM11030 Grey	TIM15604 Amber	TIM11311 Green	TIM11330 Sky Blue
Chemistry	1 part Silicone Compound	1 part Silicone Compound	1 part Silicone Grease	Kapton Polyamide Film & Silicone Coating with Acrylic PSA	Soft ceramic filled silicone with PET release liner	Soft ceramic filled silicone with PET release liner
Features	Heat Transfer Compound High Temperature Performance	High Thermal conductivity. Low oil bleed and low weight loss at elevated temperatures	Higher Thermal conductivity. Low oil bleed and low weight loss at elevated temperatures	Thermally conductive Management. Double Sided Tape with release liners	Extremely soft Gap Filler Very compliant UL94 VO rated Suitable for low pressure environment	Gap Filler with excellent compression performance Die-cutable UL94 VO rated High Thermal conductivity
Density	2.4	2.9	3.0	0.127mm Thick	0.5-6.0mm Thick	0.5-6.0mm Thick
Mixed Viscosity	Paste	Paste	Paste	D/S Tape	Pad	Pad
Thermal Conductivity	0.7 W/mK	2.1 W/mK	3.0 W/mK	0.4 W/mK	1.1 W/mK	3.0 W/mK
Temp. Performance	-54°C to 204°C	-40°C to 150°C	-40°C to 150°C	-29°C to 149°C	-54°C to 200°C	-54°C to 200°C

Techsil Limited are the UK's leading technical supplier of potting, encapsulation, sealing, bonding and thermal management materials. Techsil work in close consultation with engineers to ensure the correct performance specification is achieved by building on our years of expertise with these concepts. Key material technologies are RTV Silicones, Polyurethane, Epoxy, UV-Curing Acrylic & Epoxy, Hot Melt Adhesives, Technical Industrial Tapes and others.

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